



ELECTROPLATED EDGE GRINDING WHEEL

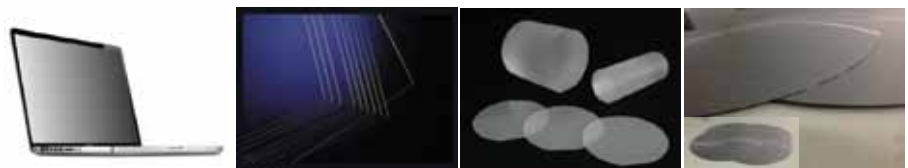


Advantages

- Due to the precision plating technology, EHWA electroplated wheel has excellent precise dimension and no non uniform profile happens.
- Superior grinding quality through optimized configuration of diamond grit size and concentration
- Double mesh wheel, Triple mesh wheel (Rough & Fine grinding)

Applications

- LCD Panel, OLED Panel, Smart Phone Cover glass, Sapphire and Silicon wafer edge grinding



Available Product Spec.

Type	Diameter	Grit Size	Bond type
ED-DW	Φ0.5 ~ Φ40	#100 ~ #1500	plating
ED-1FF6Y	Φ20 ~ Φ300		

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